## LN54

### GaAs Infrared Light Emitting Diode

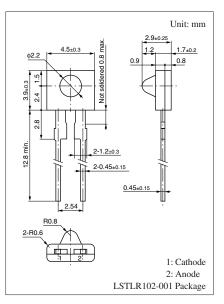
For optical control systems

#### Features

- High-power output, high-efficiency:  $P_0 = 4.6 \text{ mW}$  (typ.)
- Emitted light spectrum suited for silicon photodetectors
- Infrared light emission close to monochromatic light:  $\lambda_P = 950 \text{ nm} (typ.)$
- Small size, thin side-view type package

Absolute Maximum Hatings $T_a = 25$ C							
Symbol	Rating	Unit					
V <sub>R</sub>	3	V					
$I_{\rm F}$	50	mA					
$I_{FP}$	1	А					
P <sub>D</sub>	75	mW					
T <sub>opr</sub>	-25 to +85	°C					
T <sub>stg</sub>	-30 to +100	°C					
	Symbol V <sub>R</sub> I <sub>F</sub> P <sub>D</sub> T <sub>opr</sub>	$\begin{tabular}{ c c c c } \hline Symbol & Rating \\ \hline V_R & 3 \\ \hline I_F & 50 \\ \hline I_{FP} & 1 \\ \hline P_D & 75 \\ \hline T_{opr} & -25 \text{ to } +85 \\ \hline \end{tabular}$					

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$



Note) \*: f = 100 Hz, Duty Cycle = 0.1%

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Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 50 \text{ mA}$			1.5	V
Reverse current	I <sub>R</sub>	$V_R = 3 V$			10	μΑ
Radiant power *	Po	$I_F = 50 \text{ mA}$	2.5	4.6		mW
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 50 \text{ mA}$		950		nm
Spectral half band width	Δλ	$I_F = 50 \text{ mA}$		50		nm
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$		35		pF
Half-power angle	θ	The angle when the radiant power is halved		17		0

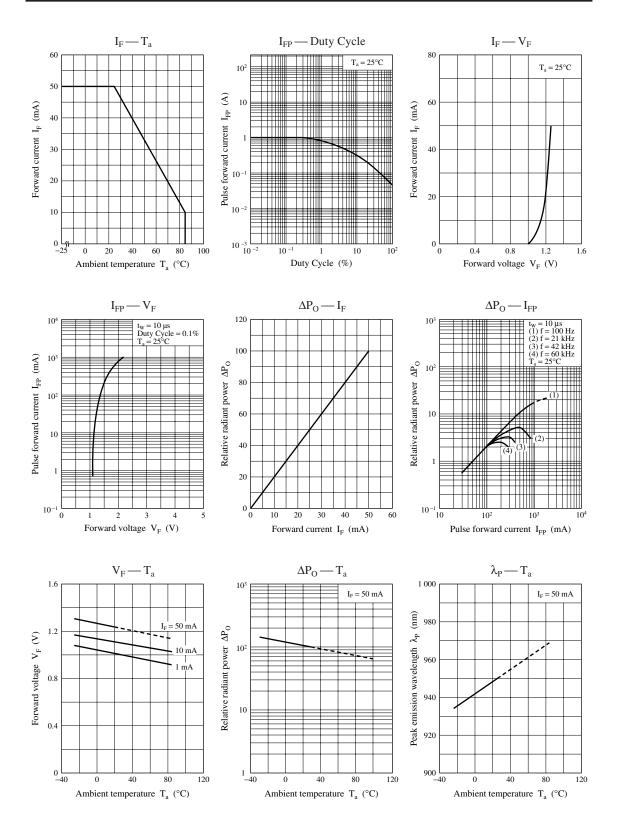
#### Electrical-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

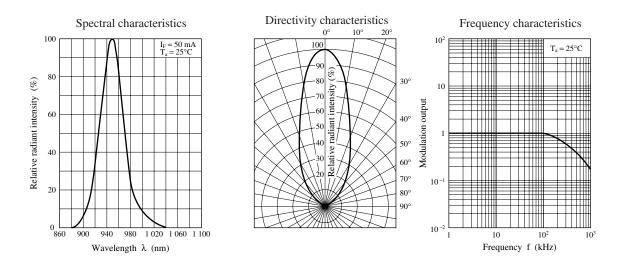
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Cutoff frequency: 1 MHz

$$f_C: 10 \times \log \frac{P_O \text{ at } f = f_C}{P_O \text{ at } f = 50 \text{ kHz}} = -3$$

3. \*: A light detection element uses a silicon diode have proofread a load with a standard device.





# ▲ Caution for Safety

# ⚠ DANGER

#### This product contains Gallium Arsenide (GaAs).

GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded form general industrial waste or household garbage.

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